TOSHIBA Power Transistor Module Silicon PNP Epitaxial Type (Darlington power transistor 4 in 1)

# **MP4305**

High Power Switching Applications.

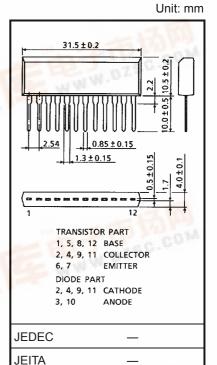
Hammer Drive, Pulse Motor Drive and Inductive Load Switching.

- Small package by full molding (SIP 12 pin)
- High collector power dissipation (4 devices operation)
   PT = 4.4 W (Ta = 25°C)
- High collector current:  $I_{C}$  (DC) = -5 A (max)
- High DC current gain:  $h_{FE} = 2000$  (min) ( $V_{CE} = -5$  V,  $I_{C} = -3$  A)
- Diode included for absorbing fly-back voltage.

#### **Maximum Ratings (Ta = 25°C)**

Characteristics		Symbol	Rating	Unit
Collector-base voltage		V <sub>CBO</sub>	-100	V
Collector-emitter voltage		V <sub>CEO</sub>	-100	V
Emitter-base voltage		V <sub>EBO</sub>	-6	V
Collector current	DC	I <sub>C</sub>	-5	Α
	Pulse	I <sub>CP</sub>	-8	A
Continuous base current		I <sub>B</sub>	-0.5	Α
Collector power dissipation (1 device operation)		PC	2.2	W
Collector power dissipation (4 devices operation)		P <sub>T</sub>	4.4	W
Junction temperature		- T <sub>j</sub>	150	°C
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C

#### **Industrial Applications**

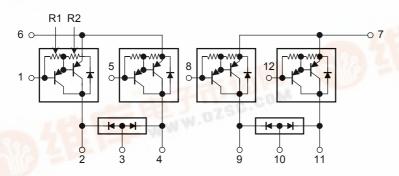


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Weight: 3.9 g (typ.)

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#### **Array Configuration**



R1 ≈ 4.5 kΩ R2 ≈ 300 Ω



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#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit	
Thermal resistance of junction to ambient	ΣR <sub>th (j-a)</sub>	28.4	°C/W	
(4 devices operation, Ta = 25°C)	· <b>u</b> · ,			
Maximum lead temperature for soldering purposes	TL	260	°C	
(3.2 mm from case for 10 s)	_			

## Electrical Characteristics (Ta = 25°C)

Charac	teristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off cu	rrent	I <sub>CBO</sub>	V <sub>CB</sub> = -100 V, I <sub>E</sub> = 0 A	_	_	-10	μΑ
Collector cut-off cu	rrent	I <sub>CEO</sub>	V <sub>CE</sub> = -100 V, I <sub>B</sub> = 0 A	_	_	-10	μΑ
Emitter cut-off curr	ent	I <sub>EBO</sub>	V <sub>EB</sub> = -6 V, I <sub>C</sub> = 0 A	-0.6	_	-2.0	mA
Collector-base brea	akdown voltage	V (BR) CBO	I <sub>C</sub> = -1 mA, I <sub>E</sub> = 0 A	-100	_	_	V
Collector-emitter bi	reakdown voltage	V (BR) CEO	I <sub>C</sub> = -10 mA, I <sub>B</sub> = 0 A	-100	_	_	V
DC current gain		h <sub>FE (1)</sub>	V <sub>CE</sub> = -5 V, I <sub>C</sub> = -3 A	2000	_	15000	_
		h <sub>FE (2)</sub>	V <sub>CE</sub> = -5 V, I <sub>C</sub> = -5 A	1000	_	_	
Saturation voltage	Collector-emitter	V <sub>CE (sat)</sub>	I <sub>C</sub> = -3 A, I <sub>B</sub> = -6 mA	_	_	-1.5	V
	Base-emitter	V <sub>BE (sat)</sub>	I <sub>C</sub> = -3 A, I <sub>B</sub> = -6 mA	_	_	-2.0	
Transition frequency		f <sub>T</sub>	V <sub>CE</sub> = -2 V, I <sub>C</sub> = -0.5 A	_	40	_	MHz
Collector output capacitance		C <sub>ob</sub>	V <sub>CB</sub> = -10 V, I <sub>E</sub> = 0 A, f = 1 MHz	_	55	_	pF
Switching time  Storage time  Fall time	Turn-on time	t <sub>on</sub>	Output Input B2	_	0.3	_	
	Storage time	t <sub>stg</sub>	20 µs   B1   W   S   C	_	2.0	_	μs
	Fall time	t <sub>f</sub>	$V_{CC}$ = -30 V $-I_{B1}$ = $I_{B2}$ = 6 mA, duty cycle ≤ 1%	_	0.4	_	

## **Emitter-Collector Diode Ratings and Characteristics (Ta = 25°C)**

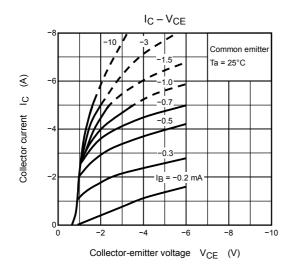
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Maximum forward current	I <sub>FM</sub>	_	_	_	3	Α
Surge current	I <sub>FSM</sub>	t = 1 s, 1 shot	_	_	6	Α
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 1 A, I <sub>B</sub> = 0 A	_	_	2.0	V
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 3 A, V <sub>BE</sub> = 3 V, dI <sub>F</sub> /dt = -50 A/μs	_	1.0	_	μs
Reverse recovery charge	Q <sub>rr</sub>		_	8	_	μC

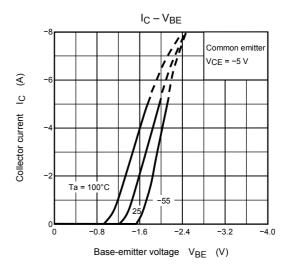
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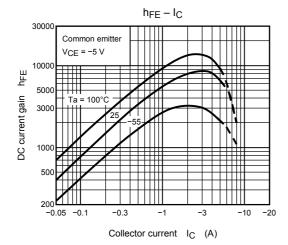
## Flyback-Diode Rating and Characteristics (Ta = 25°C)

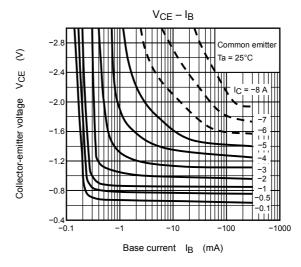
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Maximum forward current	I <sub>FM</sub>	_	_	_	3	Α
Reverse current	I <sub>R</sub>	V <sub>R</sub> = 110 V	_	_	0.4	μΑ
Reverse voltage	V <sub>R</sub>	I <sub>R</sub> = 100 μA	100	_	_	V
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 1 A	1	1	1.5	V

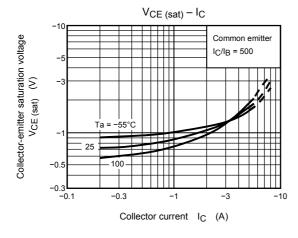
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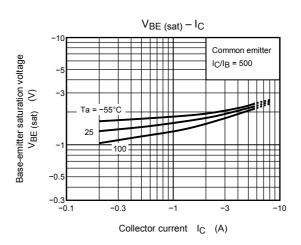


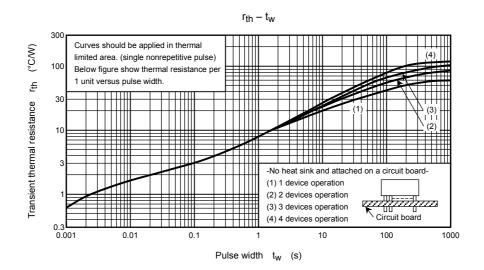


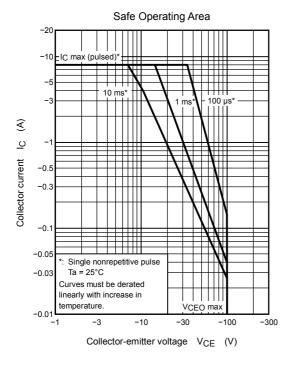


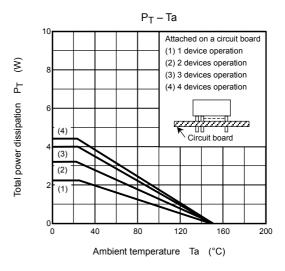


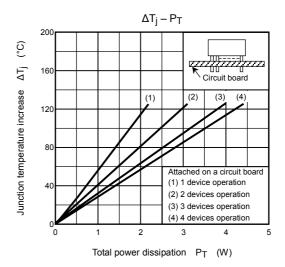












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